



N-Channel 60 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	60					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0022					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 7.5 \text{ V}$	0.0024					
Q _g typ. (nC)	128					
I _D (A)	120 ^d					
Configuration	Single					

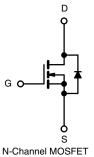
FEATURES

- TrenchFET® power MOSFET
- Maximum 175 °C junction temperature
- Q_{gd}/Q_{gs} ratio < 0.25
- Operable with logic-level gate drive
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Power supply
 - Secondary synchronous rectification
- DC/DC converter
- Power tools
- · Motor drive switch
- DC/AC inverter
- Battery management



ORDERING INFORMATION				
Package	TO-263			
Lead (Pb)-free and halogen-free	SUM50020E-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	V _{DS}	60	V			
Gate-source voltage		V _{GS}	± 20] V		
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		120 ^d			
	T _C = 70 °C	I _D	120 ^d	_		
Pulsed drain current (t = 100 μs)		I _{DM}	300	A		
Avalanche current		I _{AS}	75			
Single avalanche energy ^a	L = 0.1 mH	E _{AS}	281	mJ		
Martin and additional and	T _C = 25 °C	D	375 ^b	١٨/		
Maximum power dissipation ^a	T _C = 125 °C	P _D	125 ^b	W		
Operating junction and storage temperature range		T _{.I} , T _{sta}	-55 to +175	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	LIMIT	UNIT			
Junction-to-ambient (PCB mount) ^c	R _{thJA}	40	°C/W			
Junction-to-case (drain)	R _{thJC}	0.4	C/VV			

Notes

- a. Duty cycle ≤ 1 %
- b. See SOA curve for voltage derating
- c. When mounted on 1" square PCB (FR4 material)
- d. Package limited



Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	'			•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60	-	-	V	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	v	
Gate-body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 250	nA	
		V _{DS} = 60 V, V _{GS} = 0 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C	-	-	150	μA	
		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 175 °C	-	-	5	mA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	120	-	-	Α	
Daire and a second seco		V _{GS} = 10 V, I _D = 30 A	-	0.0018	0.0022	Ω	
Drain-source on-state resistance a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, I_D = 20 \text{ A}$	-	0.0020	0.0024		
Forward transconductance a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	-	145	-	S	
Dynamic ^b	'						
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 1 MHz	-	11 150	-	pF	
Output capacitance	Coss		-	4255	-		
Reverse transfer capacitance	C _{rss}		-	420	-		
Total gate charge ^c	Q_g		-	128	-	nC	
Gate-source charge ^c	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	44	-		
Gate-drain charge ^c	Q_{gd}		-	9	-		
Gate resistance	R_g	f = 1 MHz	0.32	1.6	3.2	Ω	
Turn-on delay time ^c	t _{d(on)}		-	18	36		
Rise time ^c	t _r	V_{DD} = 30 V, R_L = 5 Ω	-	20	40		
Turn-off delay time ^c	t _{d(off)}	$I_D\cong 10~A,~V_{GEN}=10~V,~R_g=1~\Omega$	-	55	100	ns	
Fall time ^c	t _f		-	23	35		
Drain-Source Body Diode Ratings a	nd Characteris	stics ^b (T _C = 25 °C)					
Pulsed current (t = 100 μs)	I _{SM}		-	-	300	Α	
Forward voltage ^a	V _{SD}	I _F = 10 A, V _{GS} = 0 V	-	0.8	1.5	V	
Reverse recovery time	t _{rr}		-	120	180	ns	
Peak reverse recovery charge	I _{RM(REC)}	$I_F = 39 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$	-	5.5	11	Α	
Reverse recovery charge	Q _{rr}		-	0.320	0.480	μC	

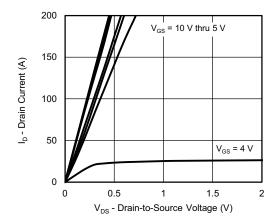
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

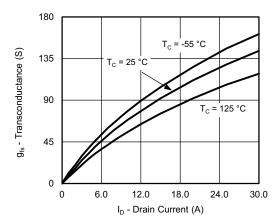
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



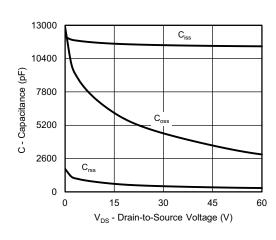
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Output Characteristics

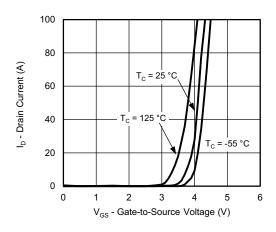


Transconductance

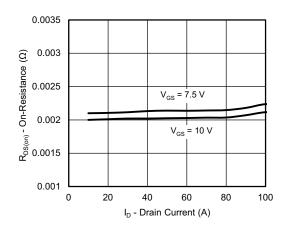


Capacitance

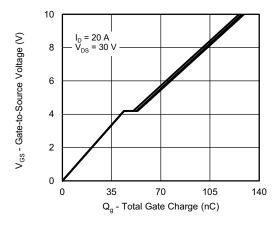
S17-1310-Rev. B, 21-Aug-17



Transfer Characteristics



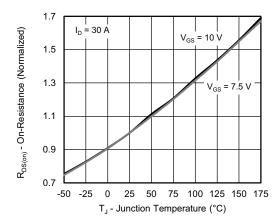
On-Resistance vs. Drain Current



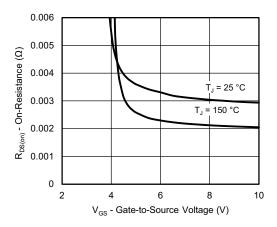
Gate Charge



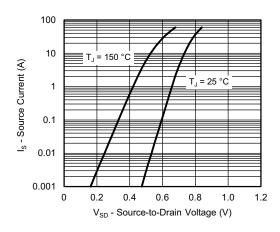
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



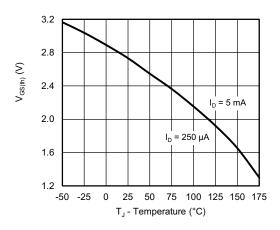
On-Resistance vs. Junction Temperature



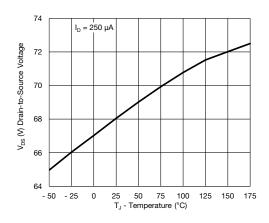
On-Resistance vs. Gate-to-Source Voltage



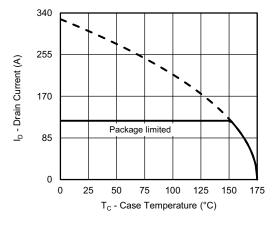
Source Drain Diode Forward Voltage



Threshold Voltage



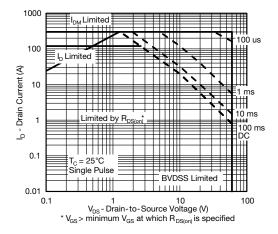
Drain Source Breakdown vs. Junction Temperature

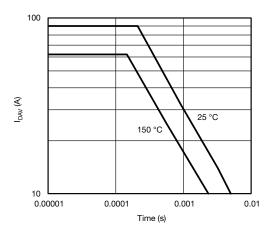


Current De-rating



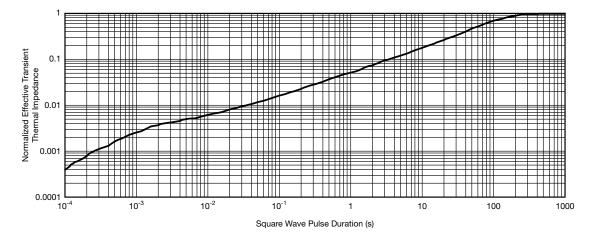
THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)





Safe Operating Area

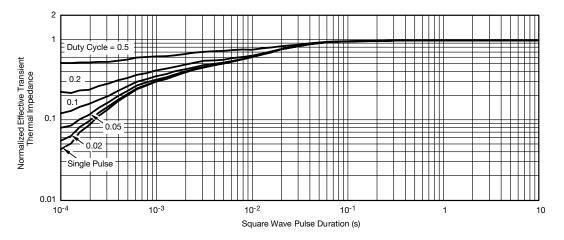
Single Pulse Avalanche Current Capability vs. Time



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

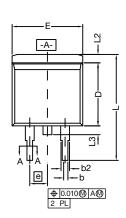
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C)

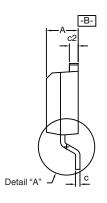
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

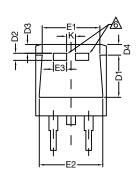
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg275403.



TO-263 (D²PAK): 3-LEAD

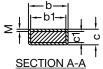








DETAIL A (ROTATED 90°)



_	,	l	o—		ļ	ļ
2:	П			C-1	_	ပ
,	SE	CTI	ON	Δ-4	Δ	Ť

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

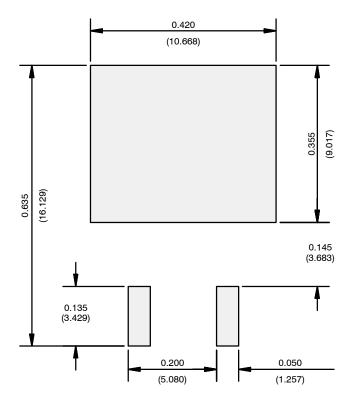
		INCHES		MILLIN	METERS
	DIM.	MIN.	MAX.	MIN.	MAX.
	Α	0.160	0.190	4.064	4.826
	b	0.020	0.039	0.508	0.990
	b1	0.020	0.035	0.508	0.889
	b2	0.045	0.055	1.143	1.397
c*	Thin lead	0.013	0.018	0.330	0.457
C	Thick lead	0.023	0.028	0.584	0.711
c1	Thin lead	0.013	0.017	0.330	0.431
CI	Thick lead	0.023	0.027	0.584	0.685
	c2	0.045	0.055	1.143	1.397
	D	0.340	0.380	8.636	9.652
	D1	0.220	0.240	5.588	6.096
	D2	0.038	0.042	0.965	1.067
	D3	0.045	0.055	1.143	1.397
	D4	0.044	0.052	1.118	1.321
	Е	0.380	0.410	9.652	10.414
	E1	0.245	-	6.223	=
	E2	0.355	0.375	9.017	9.525
	E3	0.072	0.078	1.829	1.981
	е	0.100) BSC	2.54	BSC
	K	0.045	0.055	1.143	1.397
	L	0.575	0.625	14.605	15.875
	L1	0.090	0.110	2.286	2.794
	L2 0.040		0.055	1.016	1.397
	L3	0.050	0.070	1.270	1.778
	L4 0.01		0.010 BSC		BSC
	М	-	0.002	-	0.050
ECN: T13-0707-Rev. K, 30-Sep-13					

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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